

Shard Edge PCB specification

Project name	Shard Edge
Revision	2-1, Times tamp: 20201201
Board size	226mm x 94.00mm
Number of layers	4
Material	FR-4
FR4-TG (The glass transition temperature for FR4 material):	TG 170-180
Thickness	1.6mm
Min Track / Spacing	6/6mil
Min Hole Size:	0.3mm
Solder mask	Green
Silkscreen	White
Gold fingers	NO
Surface finish	GoldPlating
Via process	All vias tented/covered with solder mask
Finished copper	1 oz Cu
Inner Copper	1 oz Cu
Half-cut/castellated holes	no
Via in pad	YES
Via filled with resin	YES
Impedance control	no
Edge plating	no